

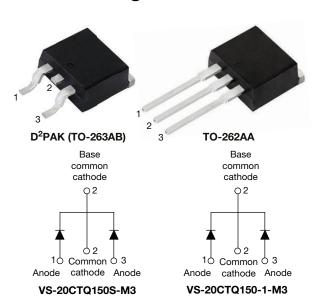
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Vishay Semiconductors

COMPLIANT

HALOGEN

High Performance Schottky Rectifier, 2 x 10 A



PRIMARY CHARACTERISTICS						
I _{F(AV)} 2 x 10 A						
V_{R}	150 V					
V _F at I _F	0.66 V					
I _{RM} max.	5.0 mA at 125 °C					
T _J max.	175 °C					
E _{AS}	1.0 mJ					
Package	D ² PAK (TO-263AB), TO-262AA					
Circuit configuration	Common cathode					

FEATURES

- 175 °C T_J operation
- Center tap configuration
- · Low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

This center tap Schottky rectifier has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL	SYMBOL CHARACTERISTICS VALUES UNITS							
I _{F(AV)}	Rectangular waveform	20	A					
V _{RRM}		150	V					
I _{FSM}	t _p = 5 μs sine	1030	A					
V _F	10 A _{pk} , T _J = 125 °C (per leg)	0.66	V					
T _J	Range	-55 to +175	°C					

VOLTAGE RATINGS							
PARAMETER SYMBOL VS-20CTQ150S-M3 UNITS							
Maximum DC reverse voltage	V _R	150	V				
Maximum working peak reverse voltage	V_{RWM}	150	V				

Revision: 21-Dec-2021 **1** Document Number: 95731 For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u>

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VS-20CTQ150S-M3, VS-20CTQ150-1-M3

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ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDI	TIONS	VALUES	UNITS			
Maximum average forward per leg								
current See fig. 5 per device	I _{F(AV)}	50 % duty cycle at T_C = 154 °C, rectangular waveform		20	Α			
Maximum peak one cycle	_	5 μs sine or 3 μs rect. pulse	Following any rated	1030	A			
non-repetitive surge current per leg See fig. 7	I _{FSM}	10 ms sine or 6 ms rect. pulse	load condition and with rated V _{RRM} applied	180				
Non-repetitive avalanche energy per leg	E _{AS}	$T_J = 25 ^{\circ}\text{C}, I_{AS} = 1 \text{A}, L = 2 \text{mH}$		1.0	mJ			
Repetitive avalanche current per leg	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		1	Α			

ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	NDITIONS	TYP.	MAX.	UNITS		
Maximum forward voltage drop per leg See fig. 1		10 A	T _J = 25 °C	0.80	0.88	V		
	V (1)	20 A	1J=25 C	0.90	1.0			
	V _{FM} ⁽¹⁾	10 A	T 405.00	0.63	0.66			
		20 A	- T _J = 125 °C	0.73	0.77			
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V _B = Rated V _B	3.0	25	μΑ		
See fig. 2		T _J = 125 °C	v _R = nateu v _R	2.7	5.0	mA		
Typical junction capacitance per leg	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), 25 °C		-	280	pF		
Typical series inductance per leg	L _S	Measured lead to lead 5 mm from package body			8.0	nΗ		
Maximum voltage rate of change	dV/dt	Rated V _R		=.	10 000	V/µs		

Note

 $^{^{(1)}\,}$ Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storag temperature range	е	T _J , T _{Stg}		-55 to +175	°C	
Maximum thermal resistance,	per leg	D	DC operation	2.0		
junction to case	per package	R _{thJC} DC operation	DC operation	1.0	°C/W	
Typical thermal resistance, case to heatsink		R _{thCS}	R _{thCS} Mounting surface, smooth and greased (Only for TO-262)		2	
Approximate weight				2	g	
Approximate weight				0.07	oz.	
May enting to you	minimum			6 (5)	kgf · cm	
Mounting torque	maximum			12 (10)	(lbf \cdot in)	
Malifer de Sa			Case style D ² PAK (TO-263AB)	20CTC	150S	
Marking device			Case style TO-262AA	20CTQ	150-1	



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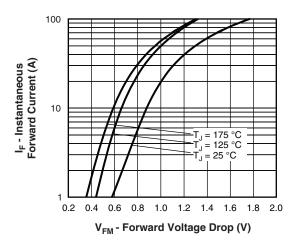


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

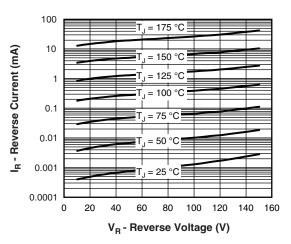


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

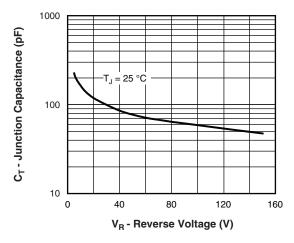


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

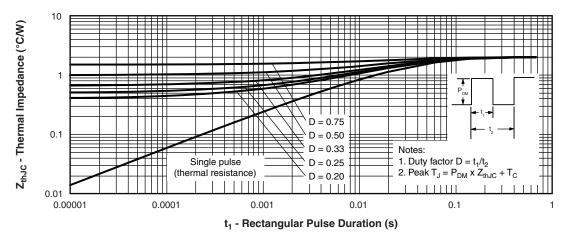
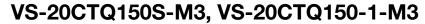


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)





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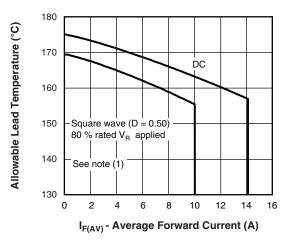


Fig. 5 - Maximum Average Forward Current vs.
Allowable Lead Temperature

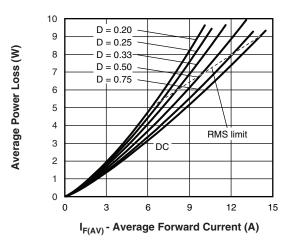


Fig. 6 - Maximum Average Forward Dissipation vs.

Average Forward Current

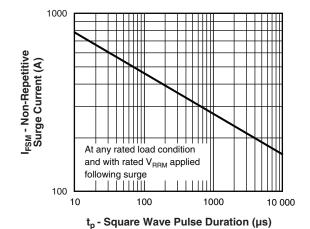


Fig. 7 - Maximum Peak Surge Forward Current vs. Pulse Duration

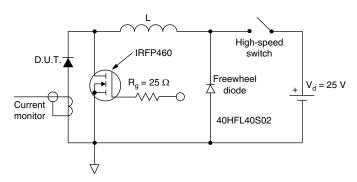


Fig. 8 - Unclamped Inductive Test Circuit

Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (\text{Pd} + \text{Pd}_{\text{REV}}) \times \text{R}_{\text{th,JC}}; \\ \text{Pd} = & \text{forward power loss} = \text{I}_{\text{F(AV)}} \times \text{V}_{\text{FM}} \text{ at } (\text{I}_{\text{F(AV)}}/\text{D)} \text{ (see fig. 6)}; \\ \text{Pd}_{\text{REV}} = & \text{inverse power loss} = \text{V}_{\text{R1}} \times \text{I}_{\text{R}} \text{ (1 - D)}; \text{I}_{\text{R}} \text{ at } \text{V}_{\text{R1}} = 80 \% \text{ rated V}_{\text{R}} \\ \end{array}$

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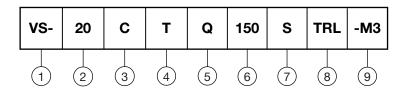


VS-20CTQ150S-M3, VS-20CTQ150-1-M3

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ORDERING INFORMATION TABLE

Device code



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Current rating (20 = 20 A)

3 - C = common cathode

4 - T = TO-220

5 - Schottky "Q" series

Voltage rating (150 = 150 V)

7 - • $S = D^2PAK (TO-263AB)$

• -1 = TO-262AA

8 - None = tube

• TRL = tape and reel (left oriented - for D²PAK (TO-263AB) only)

• TRR = tape and reel (right oriented - for D2PAK (TO-263AB) only)

9 - -M3 = halogen-free, RoHS -compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N BASE QUANTITY PACKAGING DESCRIPTION						
VS-20CTQ150S-M3	50	Antistatic plastic tubes				
VS-20CTQ150STRL-M3	800	13" diameter plastic tape and reel				
VS-20CTQ150STRR-M3	800	13" diameter plastic tape and reel				
VS-20CTQ150-1-M3	50	Antistatic plastic tubes				

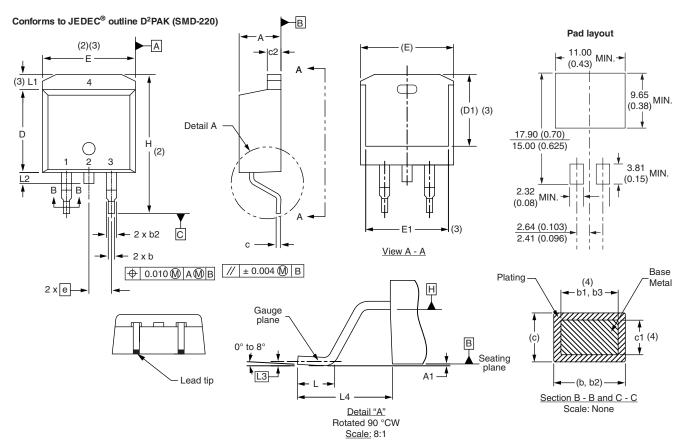
LINKS TO RELATED DOCUMENTS					
Dimensions	D ² PAK (TO-263AB)	www.vishay.com/doc?96164			
Difficusions	TO-262AA	www.vishay.com/doc?96165			
Dort marking information	D ² PAK (TO-263AB)	www.vishay.com/doc?95444			
Part marking information	TO-262AA	www.vishay.com/doc?95443			
Packaging information		www.vishay.com/doc?96424			



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D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOIES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
Е	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	2.54 BSC		BSC	
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

Notes

- $^{(1)}$ Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 08-Jul-15 1 Document Number: 95046

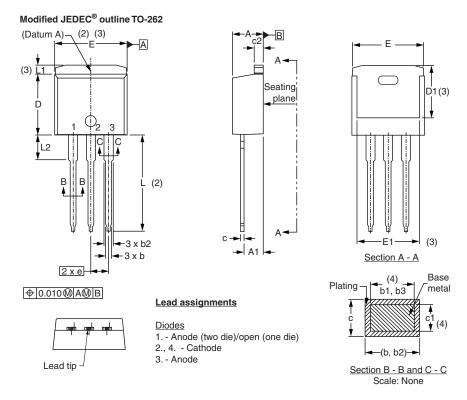




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TO-262

DIMENSIONS in millimeters and inches



CVMPOL	MILLIM	IETERS	INC	HES	NOTEC
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100) BSC	
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.36	3.71	0.132	0.146	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum), D1 (minimum) and L2 where dimensions derived the actual package outline

Revision: 11-Jul-2019 1 Document Number: 95419

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